

L Number	Hits	Search Text	DB	Time stamp
-	24	(thermoset\$4) same (copper or conductor) same (resin or adhesive) same (pcb or (circuit near board)) same (ptfe or polytetrafluoroethylene or fluoropolymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/09/23 14:11
-	48	(thermoset\$4) same (copper or conductor) same (resin or adhesive) same (pcb or (circuit near board)) same (coat or coated or coating) same (multilayer or (multi near layer))	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/09/23 14:25
-	218	(thermoset\$4) near5 (resin or adhesive) near5 (coat or coated or coating) near5 (copper or conductor)	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/09/23 14:26
-	16	((thermoset\$4) near5 (resin or adhesive) near5 (coat or coated or coating) near5 (copper or conductor)) same prepreg	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/09/23 14:26
-	26	dye near20 resin near20 prepreg	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/09/23 15:47
-	9	("2569793" "3298959" "3926658" "4183767" "4365516" "4392982" "4400618" "4538909" "4549206").PN.	USPAT	2004/09/23 15:47
-	5	4697923.URPN.	USPAT	2004/09/23 15:47
-	86	dye near20 resin near20 (fluoropolymer or ptfe or (polytetrafluoroethylene))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2004/09/23 15:49
-	0	6534160.URPN.	USPAT	2004/09/23 15:49
-	2	6254972.URPN.	USPAT	2004/09/23 15:50